

**Application No.:** 10/554,075  
**Filing Date:** September 6, 2006

## **SUMMARY OF INTERVIEW**

### Attendees, Date and Type of Interview

The telephonic interview was conducted January 26, 2011 and attended by Examiner Deborah Yee, Sabing H. Lee, Todd D. Reynolds, María Elena Palumbo, Alfonso Izquierdo, and Ettore Anelli.

### Exhibits and/or Demonstrations

None

### Identification of Claims Discussed

1 and 21

### Identification of Prior Art Discussed

Japanese Patent 09-235617 (“Kondo”)

### Proposed Amendments

Amendments as substantially set forth in the Response dated January 24, 2011.

### Principal Arguments and Other Matters

The prior art of record does not teach or suggest a microstructure having austenite grains with an average size up to 20 microns.

### Results of Interview

Upon submitting a supplemental response by the Applicants that includes remarks regarding process differences between certain embodiments of the present application and Kondo, the Office will respond accordingly.